

## 10A, 100V - 200V Trench Schottky Surface Mount Rectifier

### FEATURES

- Patented Trench Schottky technology
- Excellent high temperature stability
- Low forward voltage
- Low power loss/ high efficiency
- High forward surge capability
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

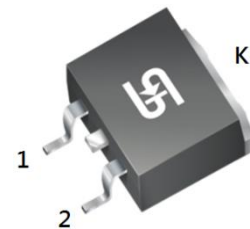
### APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converters

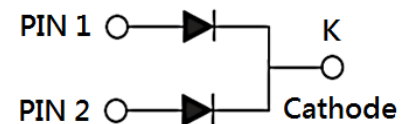
### MECHANICAL DATA

- Case: TO-263AB (D<sup>2</sup>PAK)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 1.60g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$I_F$	10	A
$V_{RRM}$	100 - 200	V
$I_{FSM}$	100	A
$T_{JMAX}$	150	°C
Package	TO-263AB (D <sup>2</sup> PAK)	
Configuration	Dual dies	



TO-263AB (D<sup>2</sup>PAK)



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER	SYMBOL	TSD10H 100CW	TSD10H 120CW	TSD10H 150CW	TSD10H 200CW	UNIT
Marking code on the device		TSD10H 100CW	TSD10H 120CW	TSD10H 150CW	TSD10H 200CW	
Repetitive peak reverse voltage	$V_{RRM}$	100	120	150	200	V
Reverse voltage, total rms value	$V_{R(RMS)}$	70	84	105	140	V
Forward current	$I_F$	10				A
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	$I_{FSM}$	100				A
Critical rate of rise of off-state voltage	dv/dt	10,000				V/ $\mu\text{s}$
Junction temperature	$T_J$	- 55 to +150				°C
Storage temperature	$T_{STG}$	- 55 to +150				°C

**THERMAL PERFORMANCE**

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-case thermal resistance	$R_{\theta JC}$	3.2	°C/W

**ELECTRICAL SPECIFICATIONS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT	
Forward voltage per diode <sup>(1)</sup>	TSD10H100CW	$I_F = 5\text{A}, T_J = 25^\circ\text{C}$	$V_F$	0.62	0.70	V
	TSD10H120CW			0.69	0.79	V
	TSD10H150CW			0.78	0.88	V
	TSD10H200CW			0.81	0.91	V
	TSD10H100CW	$I_F = 5\text{A}, T_J = 125^\circ\text{C}$		0.55	0.63	V
	TSD10H120CW			0.58	0.66	V
	TSD10H150CW			0.64	0.72	V
	TSD10H200CW			0.67	0.75	V
Reverse current @ rated $V_R$ per diode <sup>(2)</sup>	TSD10H100CW TSD10H120CW TSD10H150CW TSD10H200CW	$T_J = 25^\circ\text{C}$	$I_R$	-	100	$\mu\text{A}$
	TSD10H100CW TSD10H120CW	$T_J = 125^\circ\text{C}$		-	15	mA
	TSD10H150CW TSD10H200CW			-	10	mA

**Notes:**

1. Pulse test with  $PW = 0.3\text{ms}$
2. Pulse test with  $PW = 30\text{ms}$

**ORDERING INFORMATION**

ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING
TSD10HxCW	TO-263AB (D <sup>2</sup> PAK)	800 / Tape & Reel

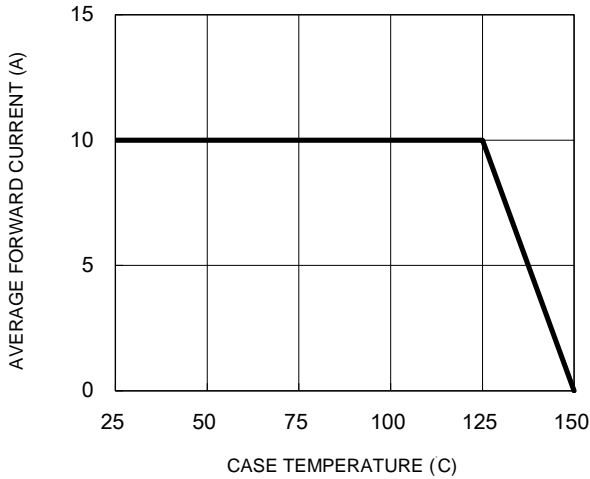
**Notes:**

1. "x" defines voltage from 100V(TSD10H100CW) to 200V(TSD10H200CW)

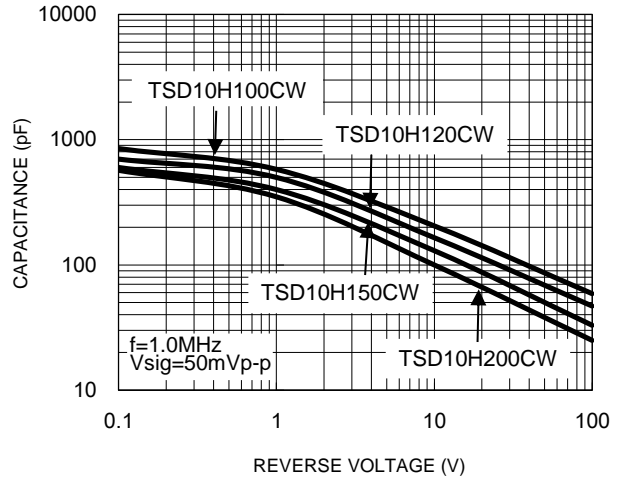
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

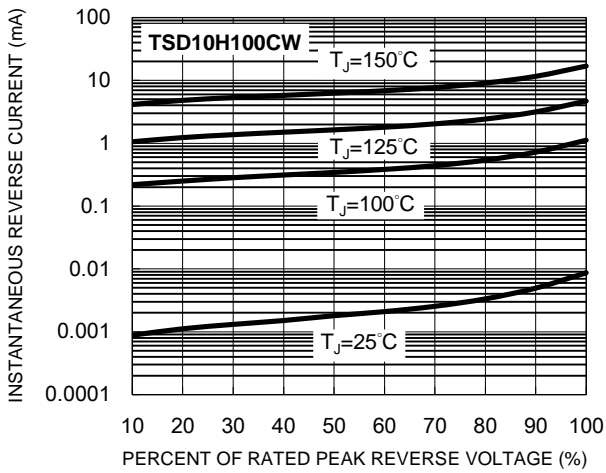
**Fig.1 Forward Current Derating Curve**



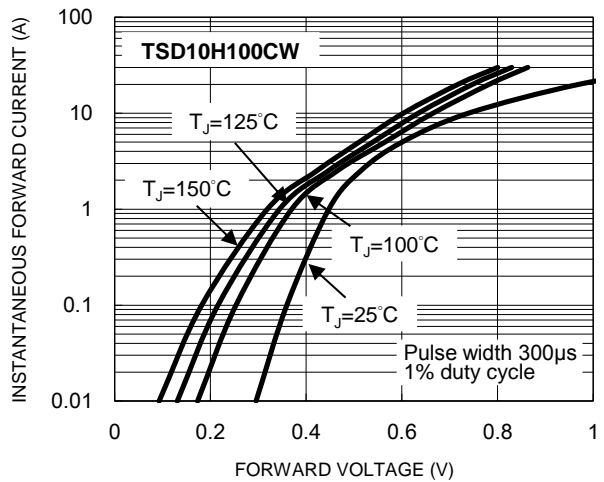
**Fig.2 Typical Junction Capacitance**



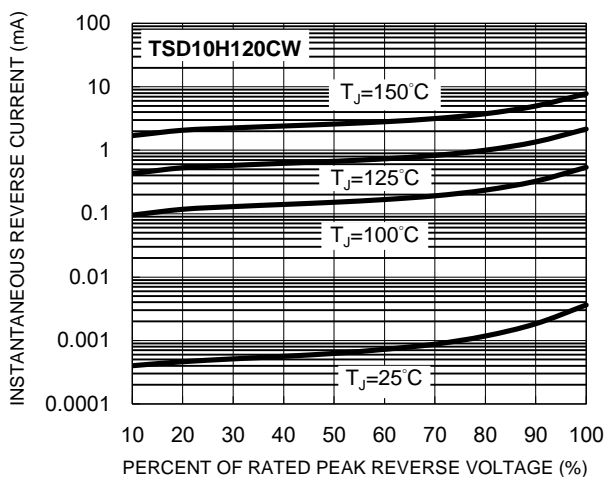
**Fig.3 Typical Reverse Characteristics**



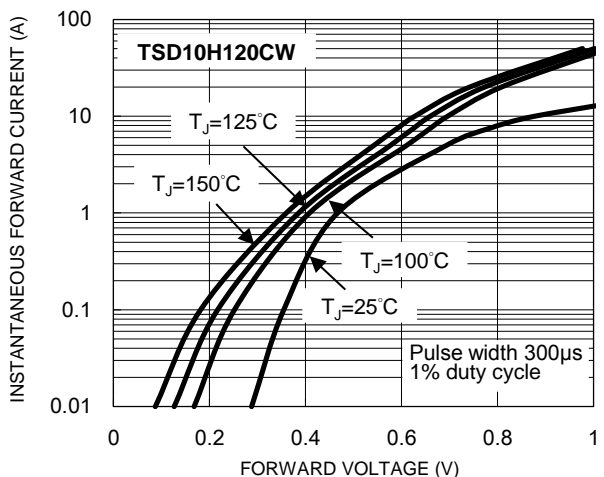
**Fig.4 Typical Forward Characteristics**



**Fig.5 Typical Reverse Characteristics**



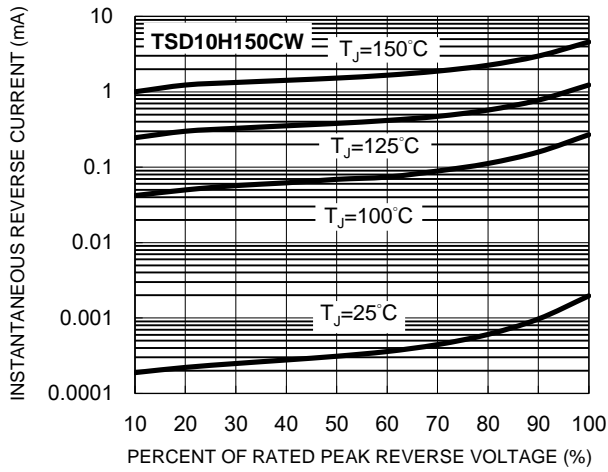
**Fig.6 Typical Forward Characteristics**



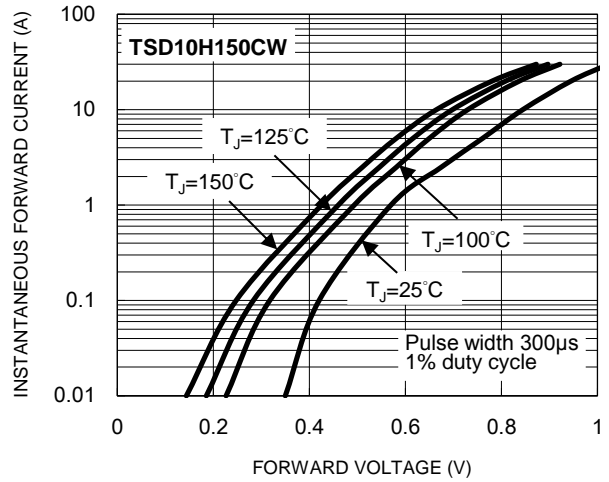
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

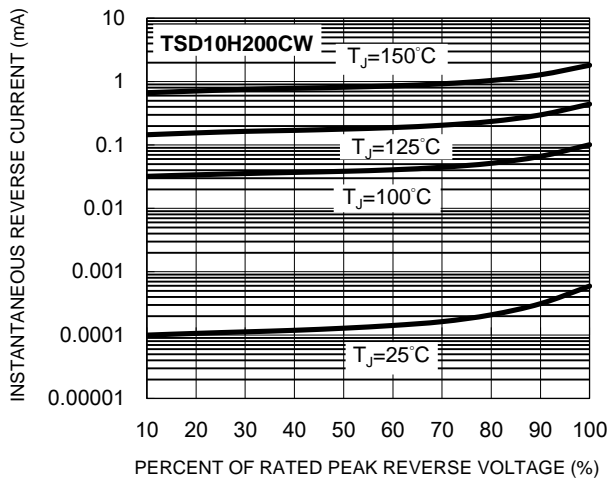
**Fig.7 Typical Reverse Characteristics**



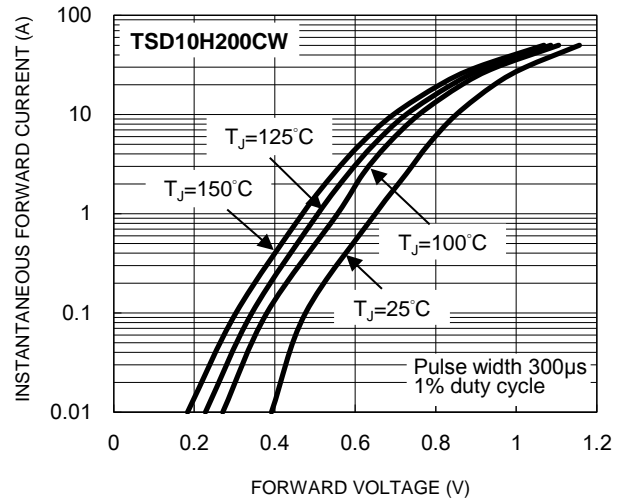
**Fig.8 Typical Forward Characteristics**



**Fig.9 Typical Reverse Characteristics**

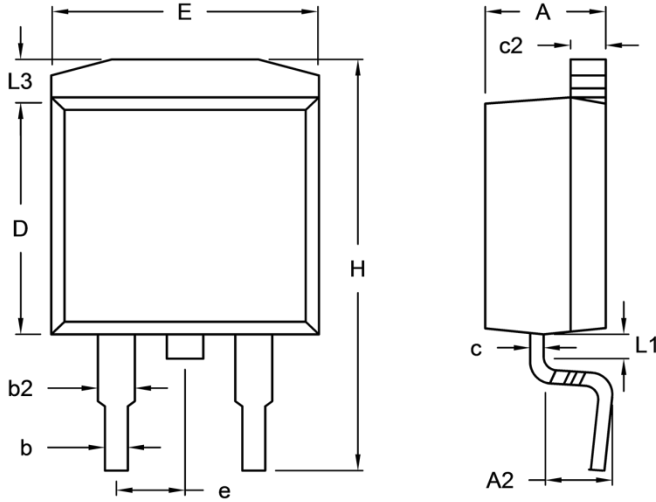


**Fig.10 Typical Forward Characteristics**



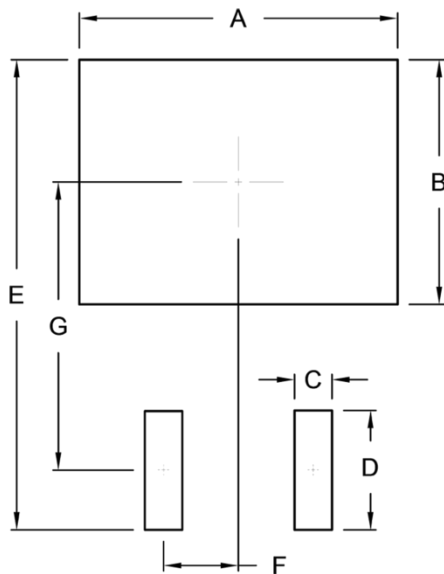
**PACKAGE OUTLINE DIMENSIONS**

TO-263AB (D<sup>2</sup>PAK)



DIM	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	4.390	4.790	0.173	0.189
A2	2.540 (TYP)		0.100 (TYP)	
b	0.675	0.975	0.027	0.038
b2	1.150	1.550	0.045	0.061
c	0.400	0.600	0.016	0.024
c2	1.150	1.450	0.045	0.057
D	8.250	9.250	0.325	0.364
E	9.600	10.050	0.378	0.396
e	2.540 (TYP)		0.100 (TYP)	
H	14.920	15.520	0.587	0.611
L1	0.900 (TYP)		0.035 (TYP)	
L3	1.400 (TYP)		0.055 (TYP)	

**SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
A	10.80	0.425
B	8.30	0.327
C	1.27	0.050
D	4.05	0.159
E	15.95	0.628
F	2.54	0.100
G	9.775	0.385

**MARKING DIAGRAM**



- P/N = Marking Code
- G = Green Compound
- YWW = Date Code
- F = Factory Code